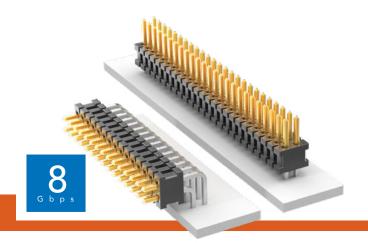
THROUGH-HOLE MICRO HEADER

(1.27 mm) .050" PITCH • FTSH SERIES



FTSH Board Mates:

CLP, FLE Cable Mates:

FFSD, FFTP

SPECIFICATIONS

Insulator Material: Black Liquid Crystal Polymer
Terminal Material: Phosphor Bronze Plating: Sn or Au over 50 µ" (1.27 µm) Ni Current Rating (FTSH/CLP): 3.4 A per pin (2 pins powered) Operating Temp Range: -55 °C to +125 °C

PROCESSING

Lead-Free Solderable:

LOCKING CLIP

For single mating cycle with the FFSD. PC BOARD □ Specify -LC after tail option. Lead Style -01 and 10 pins/row minimum. 5-9 pins/row not available in combination with keying

ALSO AVAILABLE MOQ Required

Molded Pick & Place pads Other platings

shroud (-K).



Notes:

Some sizes, styles and options are non-standard, non-returnable.

See SFM/TFM for positive alignment feature.



PER ROW

02

thru

50

LEAD STYLE

Specify

LEAD

STYLE

from

chart

PLATING

OPTION

= Gold flash on post, Matte Tin on tail

-L = 10 µ" (0.25 µm) Gold on post, Matte Tin on tail

OPTION

-ES

–EJ

-EP

-EL

Leave blank for Right-angle

OPTION

-"XXX" = Polarized Position (Specify position

Leave blank for straight tail

-RA

= Right-angle

TAIL

OPTION

of omitted pin) (Not available with -EX options)

z

(1.55) .061

(15.77) .621

(5.87) .231

((6.53) .257

-ES = End Shroud

(Style -02 & -03) 9 pins/row minimum

OTHER

OPTIONS

-EP

End Shroud with Guide Post (Style –02 & –03) 9 pins/row minimum

-EL = End Shroud with Board Lock (Style -02 & -03) 9 pins/row

–EJ

= Ejector Shroud (Style –01 only) 10 pins/row minimum 25 pins/row maximum -RA not available

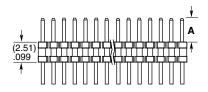
-K

= Keying Shroud for mating with FFSD With FFSD (Style –01 only, 05, 08, 10, 13, 15, 17, 20 & 25 pins/row only and 13, 17, 20 & 25 only with -EJ option)

No. of positions x (1.27) .050 + Z →	
	4.78) .188

-EX OPTION SHOWN

No. of positions x (1.27) .050 →	¥
	.43)



-RA-ES

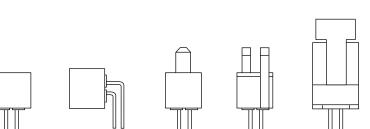
-ES



LEAD STYLE	A	MATES WITH
-01	(3.05) .120	FFSD
-02	(1.91) .075	FLE
-03	(1.65) .065	CLP-D
-04	(3.81)	N/A

-FJ





-EP

-EL

